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LCD MODULE SPECIFICATION FOR CUSTOMER'S APPROVAL

CUSTOMER	: <u>Standard</u>
MODULE TYPE	E: MTG-S12864BFGHSEB
APPROVED BY	7: (FOR CUSTOMER USE ONLY)

Approved By	Checked By	Prepared By	MT File No	Date Issued

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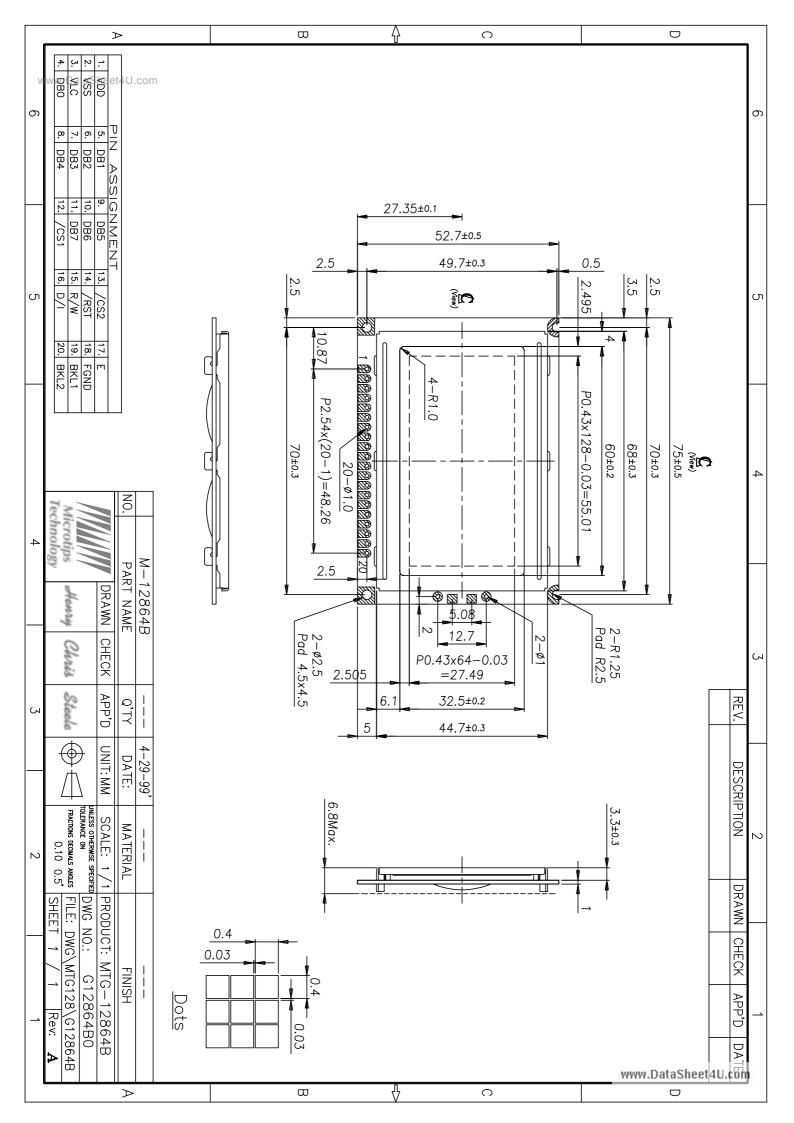
SPECIFICATION FOR LIQUID CRYSTAL DISPLAY MODULE

MODEL NO.: <u>MTG-S12864BFGHSEB</u>

View Direction	☑ 6 O'clock				□12 O'clock						
I CD T	□ FSTN	Posit	tive		☐ FSTN Negative						
LCD Type	☑ STN C	iray			ST	N Yell	ow Gre	een		STN	Blue
Rear Polarizer	□ Reflective ☑ Tr			Transflective				☐ Transmissive			
Backlight Type	□ LED	☑ EL			☐ Internal Power			☐ 5V input			
Backlight Type		□ CCF		L			□ 24V input				
Backlight Color	☐ White] An	nbe	r	⊠ Blu Gr			Yellow Green		□ Other
Temperature Range	□ Norma	.1		[☑ Wide			☐ Super Wide			
EL Driver IC	□ Build-in				☑ Not Build-in						
Touch Screen	□ With					☑ Without					

TO BE VERY CAREFUL!

The LCD driver ICs are made by CMOS process, which are very easy to be damaged by static charge, make sure the user is grounded when handling the LCM.



GENERAL SPECIFICATION

Item	Content
Display Resolution	128(W)x 64(H)
Dimensional Outline(mm)	75.0(W)× 52.7(H)× 9.0max(D)
Display mode	Transflective/ Positive Type
Circuit	Common-Driver IC, Segment-driver IC with build-in SRAM
Interface	Data (D0 \sim D7), D/I, R/W, E, RST, CS1, CS2, V_{EE}

ABSOLUTE MAXIMUN RATING

(1) Electrical Absolute Ratings

Item	Symbol	Min.	Max.	Unit	Note
Power Supply for Logic	V_{DD} - V_{SS}	-0.3	6.5	Volt	
Power Supply for LCD	$V_{ ext{DD}}$ - $V_{ ext{EE}}$	-0.3	19.0	Volt	
Input Voltage	V_{I}	-0.3	$V_{\scriptscriptstyle DD}$	Volt	
Current for LED backlight		-	200	mA	
Static Electricity	-	-	-	-	Note 1

Note 1 : Operator should be grounded during handling LCM.

(2) Environmental Absolute Maximum Ratings

	1	Normal Te	emperatur	e	Wide Temperature				
Item	Operating		Storage		Operating		Storage		
	Max,	Min.	Max,	Min.	Max,	Min.	Max,	Min.	
Ambient Temperature	0°C	+50°C	-20°C	+70°C	-20°℃	+70°C	-30°C	+80°C	
Humidity(without condensation)	Note 2,4		Note 3,5		Note	e 4,5	Note	e 4,6	

Note 2 Ta $\leq 50^{\circ}$ C: 80% RH max

Ta>50°C: Absolute humidity must be lower than the humidity of 85%RH at 50°C

- Note 3 Ta at -20°C will be <48hrs at 70°C will be <120hrs when humidity is higher than 75%.
- Note 4 Background color changes slightly depending on ambient temperature. This phenomenon is reversible.
- Note 5 $Ta \le 70^{\circ}C: 75RH \text{ max}$

Ta> 70° C: absolute humidity must be lower than the humidity of 75%RH at 70° C

Note 6 Ta at -30°C will be <48hrs, at 80 °C will be <120hrs when humidity is higher than 75%.

ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Тур	Max.	Unit	note
Power Supply for Logic	V_{DD} - V_{SS}	-	4.5	5.0	5.5	Volt	-
Innut Valtage	$ m V_{_{IL}}$	L level	V_{ss}	$0.2~\mathrm{V}_\mathrm{DD}$	-	Volt	-
Input Voltage	V_{IH}	H level	$0.8~\mathrm{V}_\mathrm{DD}$	$V_{\scriptscriptstyle DD}$	-	Volt	-
LCM Recommend		$T_a = -20^{\circ}C$	10.1	10.7	11.3		
LCD Module	$V_{\text{DD}}\!-\!\!V_{\text{EE}}$	$T_a = 25^{\circ}C$	9.5	10.3	11.0	Volt	-
Driving Voltage		$T_a = 70^{\circ}C$	9.6	10.2	10.8		
Power Supply Current for LCM	I _{DD} (LED B/L OFF)		-	1.5	1.8	4	
	$I_{\rm EE}$	$V_{DD} = 5.0 \text{V}$ $T_a = 25^{\circ}\text{C}$	-	0.6	1.0	mA	-
Power Supply for EL Backlight	$ m V_{EL}$	$V_{DD}-V_{EE}=10.3V$		100V/ 400Hz		-	-

OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Тур	Max.	Unit	note
Viewing angle range	$\theta_{\rm f}$ (12 o'clock)		35	-	-		
	$\theta_{\rm b}(6~{\rm o'clock})$	Wh C 2	40	-	-	Degree	9,10
	θ_1 (9 o'clock)	When Cr≥2	30	-	-		
	$\theta_{\rm r}$ (3 o'clock)		30	35	-		
Rise Time	$T_{\rm r}$	$ m V_{DD} ext{-}V_{EE}$		110	165	m C	
Fall Time	T_{f}	=10.3V		250	300	mS	
Contrast	Cr	Ta=25°C	-	5.34	-		7

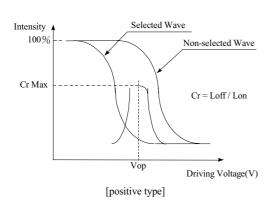
MECHANICAL SPECIFICATION

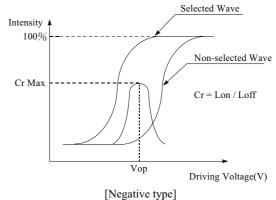
Product No.		MTG-S12864BFGHSEB
Module Size		75.0(W)× 52.7(H)× 9.0max(D)
Dot Size		0.40(W)mmx 0.40(H)mm
Dot Pitch		0.43(W)mmx 0.43(H)mm
Resolution		128(W)× 64(H) Dots Matrix
Duty Ratio		1/64 Duty
	STN	☑Gray Mode □Yellow Mode □Blue Mode
LCD Display Mode	FSTN	☐ Black & White(Normally White/Positive Image) ☐ Black & White(Normally White/Negative Image)
	Rear Polarizer:	□ Reflective □ Transflective □ Transmissive □ Transflective(High Transmissive)
Viewing Direction		☑6 O'clock □12 O'clock □3 O'clock □9 O'clock
Backlight		□W/O □CCFL ☑EL □LED
Controller		KS0108 or compatible
DC/DC Converter		Optional
EL Driver		Without

INTERFACE PIN ASSIGNMENT

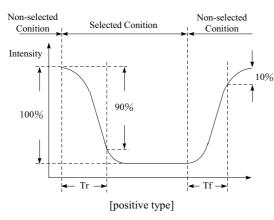
Pin No.	Pin Out	I/O	Description
1	$V_{\scriptscriptstyle DD}$	-	Logic supply voltage
2	$ m V_{SS}$	-	GND
3	$V_{\scriptscriptstyle EE}$		Supply Voltage for LCD panel.
4 11	DB0 DB7	I/O	Data bus. 3-state I/O common terminal.
12	CS1	I	Chip-select for the left half of the display. Active LOW.
13	CS2	I	Chip-select for the right half of the display. Active LOW.
14	RES	I	Setting the RES signal to Low level can initialize the following registers. 1. ON/OFF register 0 set(Display off) 2. Display start line register 0 set(display starts from line 0) After releasing reset, this condition can be changed only by software.
15	R/W	I	Read/Write R/W=high: Data of DB0~DB7 can be read by CPU. R/W=low: Data of DB0~DB7 can be written into LCD driver IC at the falling edge of E when CS1 and CS2 is high.
16	D/I	I	Data/Instruction D/I=high: Indicates that data of DB0~DB7 is display data. D/I=low: Indicates that data of DB0~DB7 is instruction.
117	E	I	Enable When write(R/W=low): Data of DB0~DB7 is latched at the fall of E When read(R/W=high): Data is read while E is at high level.
18	FGND		Frame Ground
19	BKL_A	-	Power supply for backlight.
20	BKL_K	-	(4.2V/100~150 mA DC for LED backlight, 110V/400Hz AC for EL)

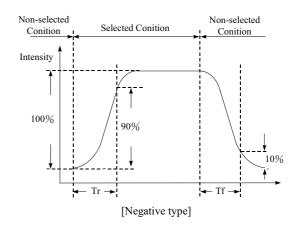
[Note 7] Definition of Operation Voltage (Vop)





[Note 8] Definition of Response Time (Tr, Tf)

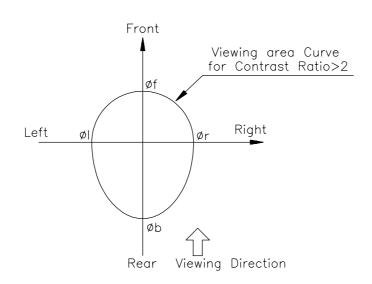




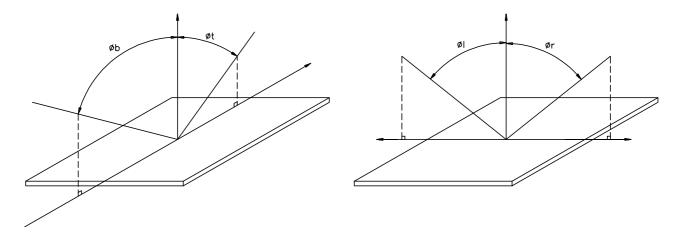
Conditions:

Operating Voltage: Vop Frame Frequency: 64 Hz Viewing Angle(θ , φ): 0°, 0° Driving Wave form: 1/N duty, 1/a bias

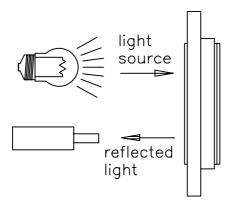
[Note 9] Definition of Viewing Direction



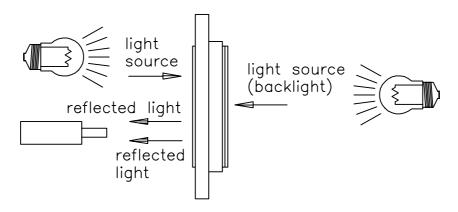
[Note 10] Definition of viewing angle



[Note 11] Description of Measuring Equipment

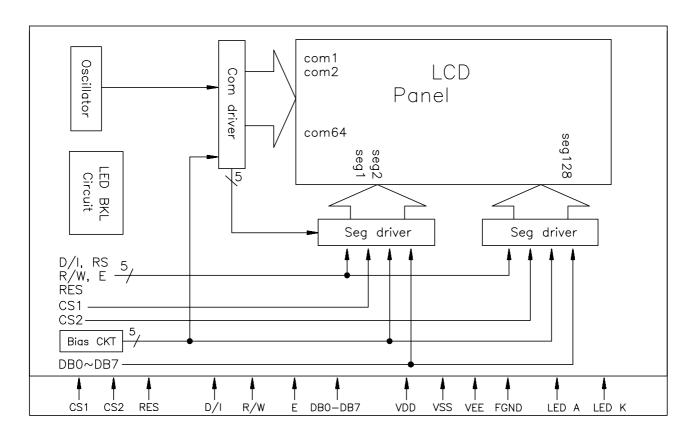


Reflective type

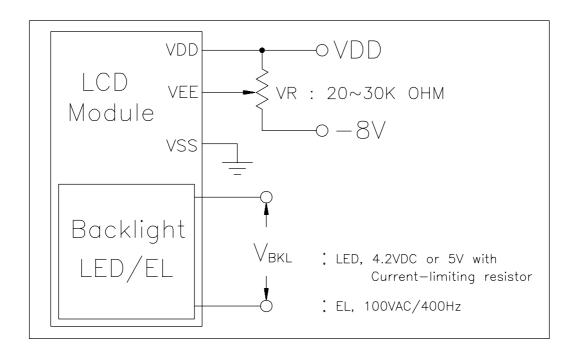


Transflective type

BLOCK DIAGRAM



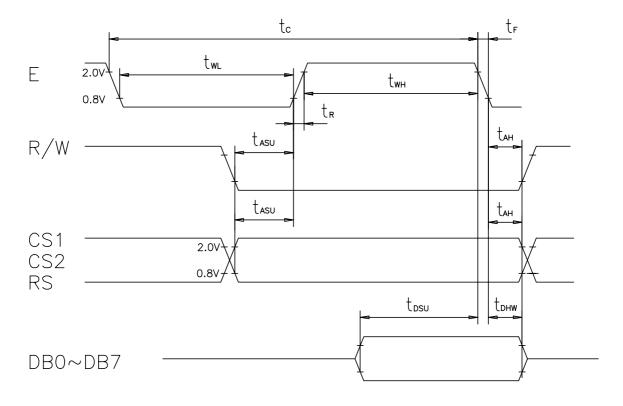
POWER SUPPLY



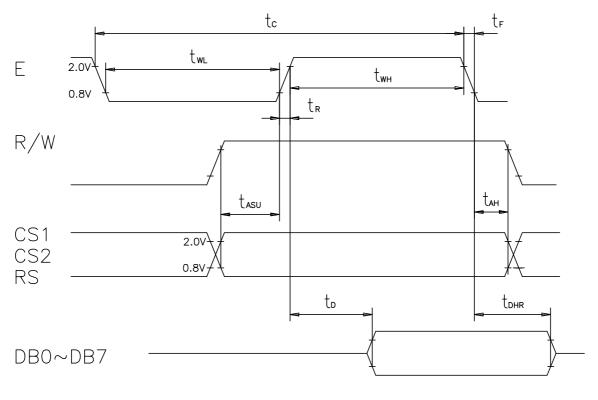
TIMING CHARACTERISTICS

MPU interface timing: (V_{SS} =0V, V_{DD} =4.5V~5.5V, T_a =-20 to 60°C)

Item	Symbol	Min.	Тур.	Max.	Unit
E Cycle Time	$t_{\rm C}$	1000	_	_	ns
E High Level Width	$t_{ m WH}$	450	_	_	ns
E Low Level Width	$t_{ m WL}$	450	_	_	ns
E Rise Time	t_R	_	_	25	ns
E Fall Time	$t_{\scriptscriptstyle \mathrm{F}}$	_	_	25	ns
Address Setup Time	$t_{ m ASU}$	140	_	_	ns
Address Hold Time	t_{AH}	10	_	_	ns
Data Setup Time	$t_{ m DSU}$	200	_	_	ns
Data Delay Time	$t_{\scriptscriptstyle D}$	_	_	320	ns
Data Hold Time(Write)	$t_{ m DHW}$	10	_	_	ns
Data Hold Time(Read)	$t_{ m DHR}$	20	_	_	ns



MPU Write Timing



MPU Read Timing

DISPLAY COMMANDS

The display commands shown below control the internal state of the LCD driver ICs. Commands

are sent from CPU to LCD module for the display control.

Command	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display ON/OFF	0	0	0	0	1	1	1	1	1	1/0	To control the display ON or OFF. The internal status and display RAM data are not affected. 0:OFF, 1:ON
Set address (Y address)	0	0	0	1	Y address $(0 \sim 63)$						To set the Y address in the Y address counter.
Set page (X address)	0	0	1	0	1	1	1 Page(0~7)			-7)	To set the X address at the X address register.
Display Start Line	0	0	1	1	Display Start Line(0~63)				To indicate the display data RAM displayed at the top of the screen.		
Status Read	0	1	Busy	0	ON/ OFF	Rese t	0	0 0 0		0	To read status of the LCD controller IC: Busy 0:Ready, 1: In operation ON/OFF: 0:Display ON, 1:Display OFF Reset: 0:Normal, 1:Reset
Write display data	1	0	Write Data						To write data into display data RAM. Y address is increased by 1 after this command.		
Read Display data	1	1	Read Data							To read data from display data RAM to the data bus.	

MEMORY MAPPING

Relationship between RAM data and display

	Relationship between KAIVI data and display														
		RAM Y address(Y0 ~Y127)									Data				
	Line $0 \rightarrow$	0	1	1	1	0	0		0	0	1	0	0	0	←DB0(LSB)
	Line 1→	1	0	0	0	1	0		0	0	1	1	0	0	←DB1
)=\	Line 2→	1	0	0	0	1	0	•••••	0	0	1	0	1	0	←DB2
page(X=0)	Line 3→	1	0	0	0	1	0		0	0	1	0	1	0	←DB3
ра§	:	1	1	1	1	1	0		0	0	1	0	0	0	←DB4
<u></u>		1	0	0	0	1	0		1	1	1	0	0	0	←DB5
1st	:	1	0	0	0	1	0		1	1	1	0	0	0	←DB6
	Line 7→	0	0	0	0	0	0		0	0	0	0	0	0	←DB7(MSB)
	Line 8→	1	1	1	1	0	0		0	1	1	1	0	0	←DB0(LSB)
	Line 9→		0	0	0	1	0		0	1	0	0	1	0	←DB1
page(X=1)	Line 10→	1	0	0	0	1	0		0	1	0	0	1	0	←DB2
ge(1	1	1	1	0	0		1	1	1	0	1	0	←DB3
pa		1	0	0	0	1	0		0	1	0	0	1	0	←DB4
2nd		1	0	0	0	1	0		0	1	0	0	1	0	←DB5
2r	•	1	1	1	1	0	0		0	1	1	1	0	0	←DB6
	Line 15→	0	0	0	0	0	0		0	0	0	0	0	0	←DB7(MSB)
	i														
	Line 56→	1	0	0	0	1	0	•••••	0	0	0	0	0	0	←DB0(LSB)
		1	0	0	0	1	0		0	0	0	0	0	0	←DB1
X=7		1	0	0	0	1	0		0	1	0	0	1	0	←DB2
page(X=7)		1	1	1	1	1	0		1	0	1	0	1	0	←DB3
pag		1	0	0	0	1	0		1	0	0	1	0	0	←DB4
8th	-	1	0	0	0	1	0		1	0	0	1	0	0	←DB5
81	Line 62→	1	0	0	0	1	0		0	1	1	0	1	0	←DB6
	Line 63→	0	0	0	0	0	0) ! !				←DB7(MSB)

ADDRESS CONFIGURATION OF DISPLAY DATA RAM

			Y address	
	0 1	2	3126	127
	DB0			Line0
$X=0 \rightarrow$	To		Page0	То
	DB7			Line7
	DB0			Line8
$X=1 \rightarrow$	To		Page1	То
	DB7			Line15
	DB0			Line16
$X=2\rightarrow$	To		Page2	То
	DB7			Line23
	DB0			Lint24
$X=3\rightarrow$	To		Page3	То
	DB7			Line31
	DB0			Line32
$X=4\rightarrow$	To		Page4	То
	DB7			Line39
	DB0			Line40
$X=5 \rightarrow$	To		Page5	То
	DB7			Line47
	DB0			Line48
X=6→	To		Page6	То
	DB7			Line55
	DB0			Line56
X=7→	To		Page7	То
	DB7			Line63

Address configuration of Display Data RAM

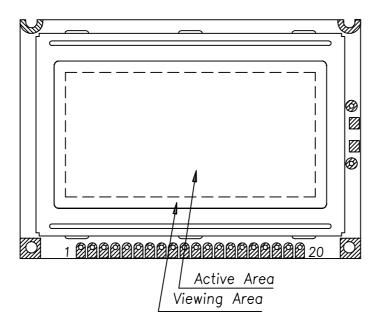
RELIABILITY TEST

No	Item	Conditions	Note	
1	High Temp. Operation	70℃	240 Hr	
2	High Temp. Storage	80°C	240 Hr	
3	Low Temp. Operation	-20℃	240 Hr	
4	Low Temp. Storage	-30℃	240 Hr	
5	High Temp./Humid Storage	60℃ 90%RH	240 Hr	
6	Thermal Shock	-20°C ,30min +60°C ,30min	10 cycles	
7	Vibration Test (IEC-68-2-6)	Frequency: 10~55 Hz Duration: 20 times, 6 min/time Amplitude: 0.75 mm	-	
8	Shock (IEC 68-2-27)	Duration : 11 mS Acceleration : 100g	-	X, Y, Z direction

APPEARANCE CHECK

CONDIITON OF APPEARANCE CHECK:

- (1) Specimen shall be checked by eyes in distance of 30cm under 40w-fluorescence lamp.
- (2) Checking direction shall be in 45 degree from perpendicular line op specimen surface.



HANDLING PRECAUTIONS

- (1) Treat polarizer very carefully since it is easy to be damaged.
- (2) When cleaning the display surface, use soft cloth (e.g. gauss) with a solvent (recommended below) and wipe lightly.
 - ethyl alcohol
 - ♦ iso-prcolol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvents:

- water
- **♦** ketone
- aromatics
- (3)Direct current causes electro-chemical reaction with remarkable degradation of the display quality. Give careful consideration to prevent direct current at ON/OFF timing and during operation.
- (4) Avoid strong shock and drop from the height.
- (5)To prevent LCD panels from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.
- (6) Give careful consideration to avoid electrical static discharge with causes uneven contrast.
- (7)Even a small condensation on the contact pads (terminals) causes electro-chemical reaction which makes missing row and column. Give careful attention to avoid condensation. When assembling with zebra connector, clean the surface of the pads with alcohol and keep the air very clean.

LCD PRODUCT QUALITY STANDARD DISPLAY APPEARANCE

No	Item	Criteria
		(1)round type
		diameter mm(a*) no of defect*
		$a \leq 0.20$ neglect
		$0.20 < a \le 0.35$ 5max
1	inclusions (black spot,	0.35 < a none
1	white spot, dust)	(2)linear type
		length mm(l) width mm(W) no. of defect
		na $W \leq 0.03$ neglect
		$1 \le 3$ $0.03 < W \le 0.08$ 6
		3 < 1 0.08 $<$ W none
		1. scratch on protective film is permitted.
		2. scratch on polarizer shall be as follow:
		(1)round type
		diameter mm(a*) no of defect
2	scratch	$a \le 0.15$ neglect
		$0.15 < a \le 0.20$ 2 max
		0.20 < a none
		(2) linear type
		be judged bye 1(2) linear type
3	dent	diameter < 1.5mm
4	bubble	not exceeding 0.5mm average diameter is acceptable between glass
		and polarizing film $(a+b)/2 \leq 0.15 \text{mm}$
		maximum number: ignored
5	pin hole	$0.15 < (a+b)/2 \le 0.20$ mm
		maximum number:10
		$(a+b)/2 \le 0.20$ mm
		maximum number: ignored
6	dot defect	$0.20 < (a+b)/2 \le 0.30 \text{mm}$
		maximum number:5
		x=width
		diameter spec no of defect
		$a \le 0.50 mm$ neglect
7	contrast irregularity(spot)	$0.50 < a \le 0.75$
		$0.75 < a \le 1.00$
		1.00 < a none
8	dot width	design width ±15%
9	color tone and uniformity	obvious uneven color is not permitted

REVISION HISTORY

Revision Content	Page	Date
Pin Assignment, #12 and #13 changed to CS1\ and CS2\	8	1999/12/10